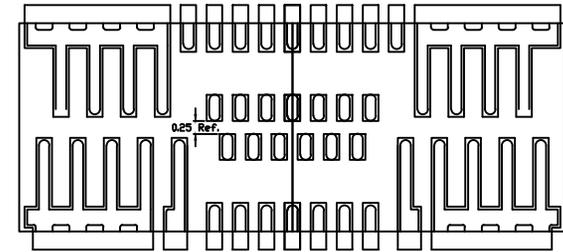
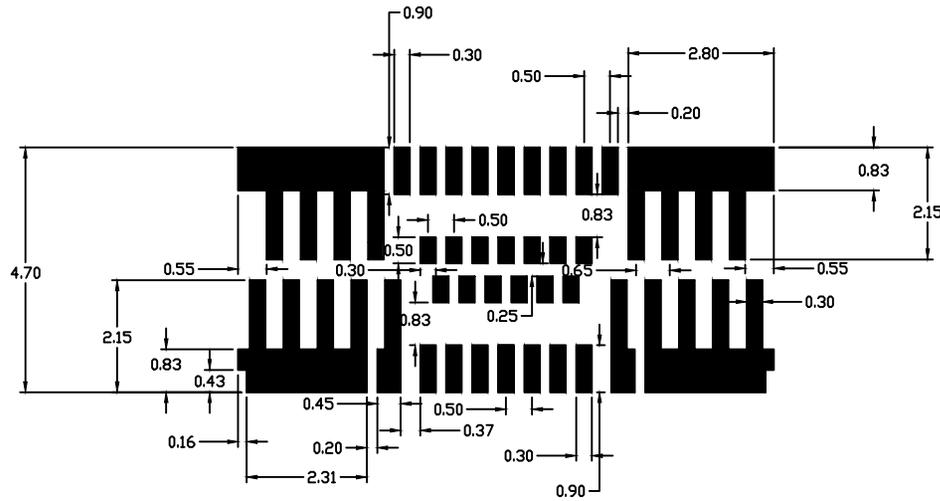


RECOMMENDED LAND PATTERN

PACKAGE OVERLAY



NOTES:

1. REFERENCE PKG. OUTLINE: 21-100023.
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES.
5. ALL DIMENSIONS IN MM.
6. REFER TO APPLICATION NOTES 5963 FOR SMT STENCIL DESIGN RECOMMENDATIONS

-DRAWING NOT TO SCALE-



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown to Analog Devices Inc. (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

TITLE:  
PACKAGE LAND PATTERN,  
[F354A10F+2] FC2-GQFN/FC2-MIS

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